

1.2V Drive Nch MOSFET

RUB002N02

● Structure

Silicon N-channel MOSFET

● Features

- 1) High speed switing.
- 2) Small package(VMN3).
- 3) Ultra low voltage drive(1.2V drive).

● Application

Switching

● Packaging specifications

Type	Package	Taping
	Code	T2CL
	Basic ordering unit (pieces)	8000
RUB002N02		○

● Absolute maximum ratings (Ta = 25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		V_{DSS}	20	V
Gate-source voltage		V_{GSS}	±8	V
Drain current	Continuous	I_D	±200	mA
	Pulsed	I_{DP} *1	±800	mA
Source current (Body Diode)	Continuous	I_S	125	mA
	Pulsed	I_{SP} *1	800	mA
Power dissipation		P_D *2	150	mW
Channel temperature		Tch	150	°C
Range of storage temperature		Tstg	-55 to +150	°C

 *1 $P_w \leq 10\mu s$, Duty cycle $\leq 1\%$

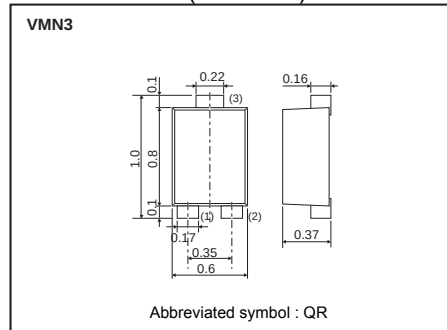
*2 Each terminal mounted on a recommended land.

● Thermal resistance

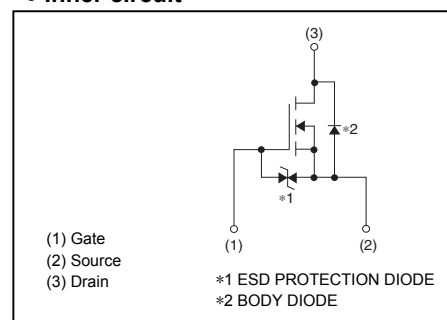
Parameter	Symbol	Limits	Unit
Channel to Ambient	Rth (ch-a)*	833	°C / W

* Each terminal mounted on a recommended land.

● Dimensions (Unit : mm)



● Inner circuit



● Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	-	-	± 10	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	20	-	-	V	$I_D = 1mA, V_{GS} = 0V$
Zero gate voltage drain current	I_{DSS}	-	-	1	μA	$V_{DS} = 20V, V_{GS} = 0V$
Gate threshold voltage	$V_{GS(th)}$	0.3	-	1.0	V	$V_{DS} = 10V, I_D = 1mA$
Static drain-source on-state resistance	$R_{DS(on)}^*$	-	0.7	1.0	Ω	$I_D = 200mA, V_{GS} = 4V$
		-	0.8	1.2		$I_D = 200mA, V_{GS} = 2.5V$
		-	1.0	1.4		$I_D = 200mA, V_{GS} = 1.8V$
		-	1.2	2.4		$I_D = 40mA, V_{GS} = 1.5V$
		-	1.6	4.8		$I_D = 20mA, V_{GS} = 1.2V$
Forward transfer admittance	$ Y_{fs} ^*$	0.2	-	-	S	$I_D = 200mA, V_{DS} = 10V$
Input capacitance	C_{iss}	-	25	-	pF	$V_{DS} = 10V$
Output capacitance	C_{oss}	-	10	-	pF	$V_{GS} = 0V$
Reverse transfer capacitance	C_{rss}	-	10	-	pF	$f = 1MHz$
Turn-on delay time	$t_{d(on)}^*$	-	5	-	ns	$I_D = 150mA, V_{DD} = 10V$
Rise time	t_r^*	-	10	-	ns	$V_{GS} = 4V$
Turn-off delay time	$t_{d(off)}^*$	-	15	-	ns	$R_L = 67\Omega$
Fall time	t_f^*	-	10	-	ns	$R_G = 10\Omega$

*Pulsed

● Body diode characteristics (Source-Drain) (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward Voltage	V_{SD}^*	-	-	1.2	V	$I_S = 200mA, V_{GS} = 0V$

*Pulsed

●Electrical characteristic curves (Ta=25°C)

Fig.1 Typical Output Characteristics(I)

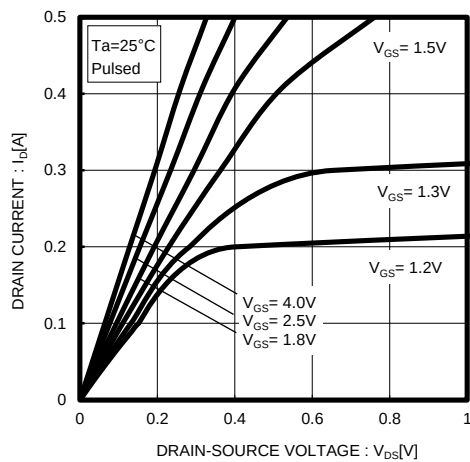


Fig.2 Typical Output Characteristics(II)

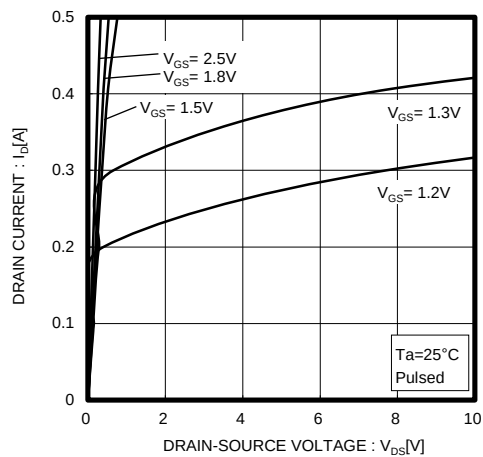


Fig.3 Typical transfer characteristics

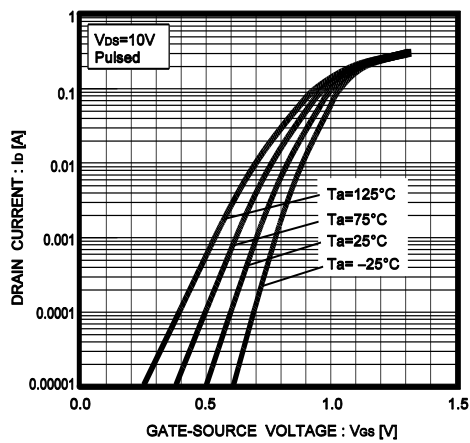


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current(I)

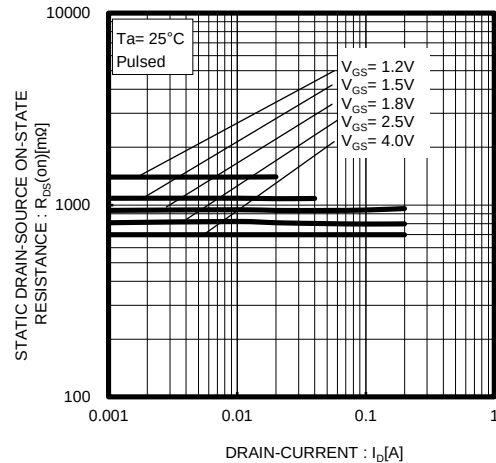


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current(II)

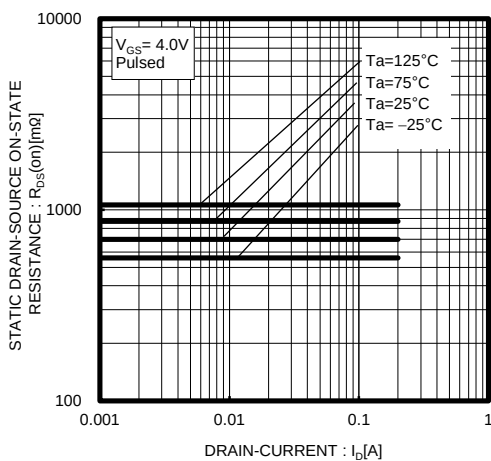


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current(II)

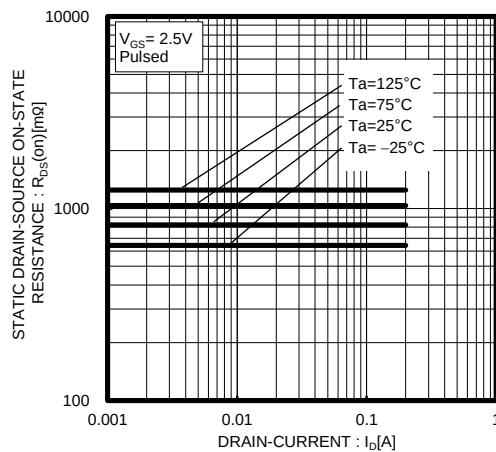


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current(III)

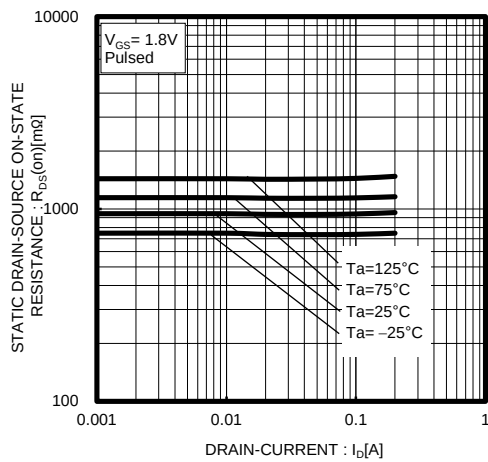


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current(IV)

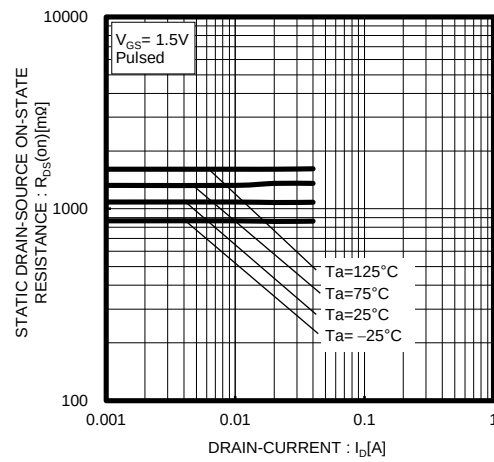


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current(V)

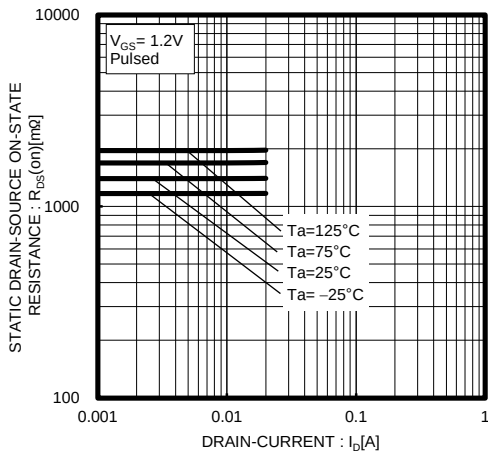


Fig.10 Forward Transfer Admittance vs. Drain Current

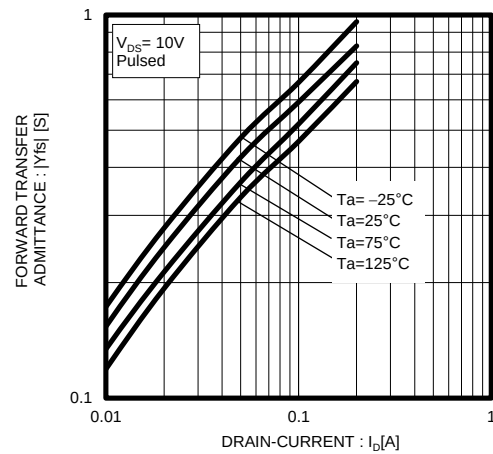


Fig.11 Source current vs. source-drain voltage

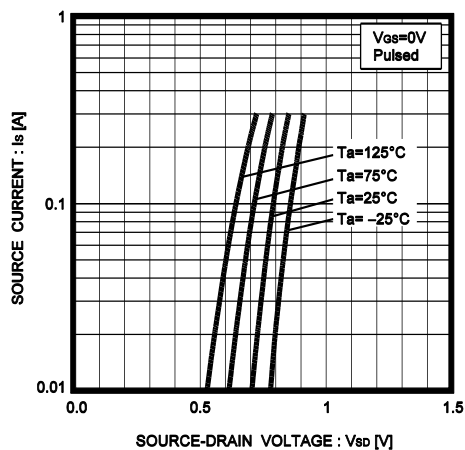


Fig.12 Static Drain-Source On-State Resistance vs. Gate Source Voltage

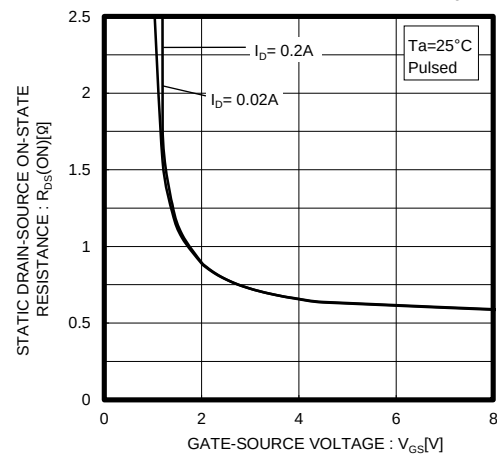


Fig.13 Switching characteristics

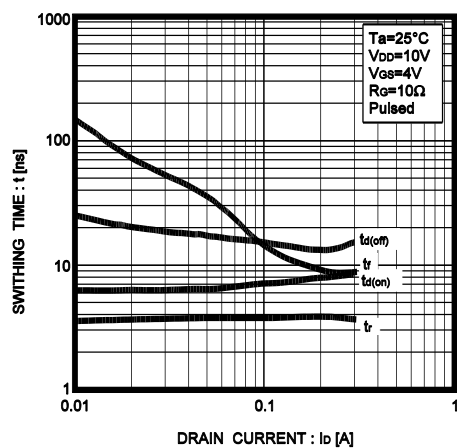
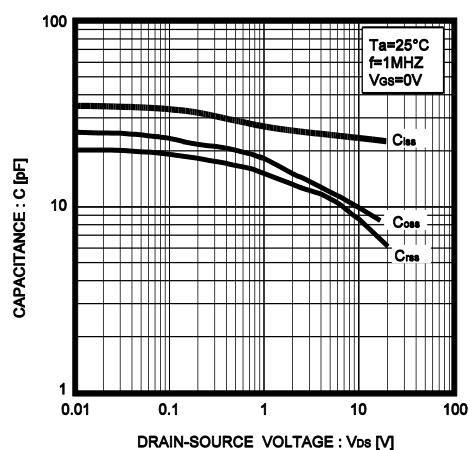


Fig.14 Typical capacitance vs. drain-source voltage



● Measurement circuits

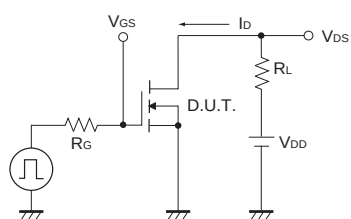


Fig.1-1 Switching Time Measurement Circuit

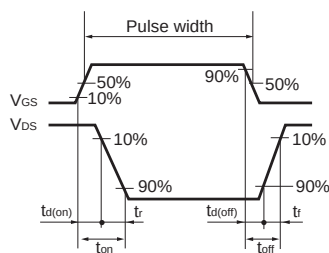


Fig.1-2 Switching Waveforms

● Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

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